

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/559923	Confirmation No.	1496
Applicant	:	Yoshinari Tsukada et al.		
Filed	:	December 8, 2005		
TC/A.U.	:	2826		
Examiner	:	Alexander O. Williams		
Title	:	SEMICONDUCTOR DEVICE REDUCING WARPING DUE TO HEAT PRODUCTION (as amended)		
Docket No.	:	SHM-16366		
Customer No.	:	040854		

REQUEST FOR SUPPLEMENTAL NOTICE OF ALLOWANCE

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir/Madam:

In the "Notice of Allowance" that was mailed from the U.S. Patent and Trademark Office on September 8, 2008 for the above-identified application, there is an error in the "Title Of Invention". The title should read as follows:

Title Of Invention: SEMICONDUCTOR DEVICE REDUCING WARPING
DUE TO HEAT PRODUCTION

Applicant requests that a Supplemental Notice of Allowance be issued acknowledging the correct title in this application.

Respectfully submitted,

RANKIN, HILL, PORTER & CLARK LLP

By /David E. Spaw/
David E. Spaw, Reg. No. 34732

38210 Glenn Avenue
Willoughby, Ohio 44094-7808
(216) 566-9700

September 16, 2008